507227195 04/12/2022

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7274048

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WEI-FAN CHEN	03/26/2022
KUO-CHI TSAI	03/29/2022

RECEIVING PARTY DATA

Name:	LEAP SEMICONDUCTOR CORP.	
Street Address:	3F, NO.86-7, YIWEN 1ST ST., TAOYUAN DIST.,	
City:	TAOYUAN CITY	
State/Country:	TAIWAN	
Postal Code:	33045	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17711013

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	114362-US-PA
NAME OF SUBMITTER:	JOSEPH SU
SIGNATURE:	/Joseph Su/
DATE SIGNED:	04/12/2022

Total Attachments: 3

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PATENT 507227195 REEL: 059566 FRAME: 0472

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION Declaration Submitted With Initial Filing				
OR				
Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)				
(Title of the Invention)				
MERGED PIN SCHOTTKY (MPS) DIODE AND METHOD OF MANUFACTURING THE SAME				
As a below named inventor (hereinafter designated as the undersigned), I hereby				
declare that:				
This declaration is directed to:				
∑ The attached application,				
OR				
United States Application Number or PCT International application number				
Filed on				
The above-identified application was made or authorized to be made by me.				
l believe I am the original inventor or an original joint inventor of a claimed invention in the application.				

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more

than five (5) years, or both.

PATENT REEL: 059566 FRAME: 0473 1 114362-US-PA

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS, 1. LEAP Semiconductor Corp.

of 3F, No.86-7, Yiwen 1st St., Taoyuan Dist., Taoyuan City 33045, Taiwan

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

PATENT REEL: 059566 FRAME: 0474

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Wit - Fan Chen	Date: 3/26/2022
Legal Name of Sole or First Inventor: Wei-Fan Chen	
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signature: Kw - Chi Tscii	Date: 3/29 /2022
Legal Name of Additional Joint Inventor, if any: Kuo-C	
Residence: Taoyuan City, Talwan	

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